2SA2029 / 2SA1774EB / 2SA1774 2SA1576UB / 2SA1576U3 / 2SA1037AK

General purpose Transistor (-50V, -150mA)

#### Datasheet

Parameter	Value
V <sub>CEO</sub>	-50V
Ι <sub>C</sub>	-150mA

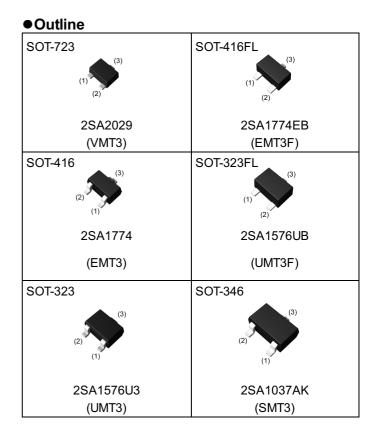
### Features

1)Excellent h<sub>FE</sub> linearity.

2)Complements the 2SC5658/2SC4617EB/ 2SC4617/2SC4081UB/2SC4081U3/2SC2412K

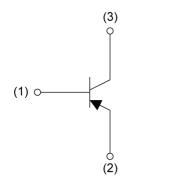
### Application

GENERAL PURPOSE SMALL SIGNAL AMPLIFIER



## Inner circuit

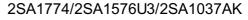
2SA2029/2SA1774EB/2SA1576UB

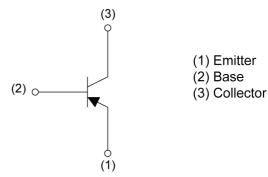


(1) Base

(2) Emitter

(3) Collector





## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	hFE rank	Marking
2SA2029	SOT-723	1212	T2L	180	8	8000	QRS	F
2SA1774EB	SOT-416FL	1616	TL	180	8	3000	QRS	F
2SA1774	SOT-416	1616	TL	180	8	3000	QRS	F
2SA1576UB	SOT-323FL	2021	TL	180	8	3000	QRS	F
2SA1576U3	SOT-323	2021	T106	180	8	3000	QRS	F
2SA1037AK	SOT-346	2928	T148	180	8	3000	QRS	F

F	Parameter	Symbol	Values	Unit
Collector-base voltage		V <sub>CBO</sub>	-60	V
Collector-emitter voltage	V <sub>CEO</sub>	-50	V	
Emitter-base voltage		V <sub>EBO</sub>	-6	V
		Ι <sub>C</sub>	-150	mA
Collector current		I <sub>CP</sub> <sup>*1</sup> -200		mA
	2SA2029		150	
	2SA1774EB		150	
	2SA1774	<b>D</b> *2	150	
Power dissipation	2SA1576UB	P <sub>D</sub> <sup>*2</sup>	200	— mW
	2SA1576U3		200	
	2SA1037AK		200	
Junction temperature		Tj	150	°C
Range of storage tempera	ature	T <sub>stg</sub>	-55 to +150	°C

## • Absolute maximum ratings ( $T_a = 25^{\circ}C$ )

# •Electrical characteristics (T<sub>a</sub> = 25°C)

Deremeter	Current al	Conditions		Values		Linit
Parameter	Symbol	Conditions	Min.	Min. Typ. Max.		Unit
Collector-base breakdown voltage	$BV_{CBO}$	Ι <sub>C</sub> = -50μΑ	-60	-	-	V
Collector-emitter breakdown voltage	$BV_{CEO}$	I <sub>C</sub> = -1mA	-50	-	-	V
Emitter-base breakdown voltage	$BV_{EBO}$	Ι <sub>Ε</sub> = -50μΑ	-6	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -60V	-	-	-100	nA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = -6V	-	-	-100	nA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = -50mA, I <sub>B</sub> = -5mA	-	-	-500	mV
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> = -6V, I <sub>C</sub> = -1mA	120	-	560	-
Transition frequency	f <sub>T</sub>	V <sub>CE</sub> = -12V, I <sub>E</sub> = 2mA, f = 100MHz	-	140	-	MHz
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = -12V, I <sub>E</sub> = 0A, f = 1MHz	-	4.0	5.0	pF

## hFE values are calssified as follows :

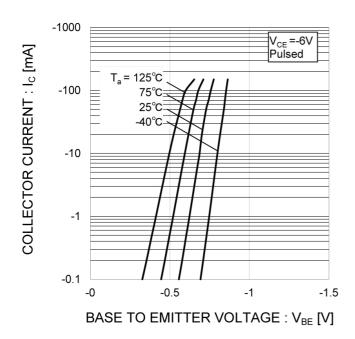
rank	Q	R	S	-	-
h <sub>FE</sub>	120-270	180-390	270-560	-	-

\*1 Pw=1ms, Single Pulse.

\*2 Each terminal mounted on a reference land.

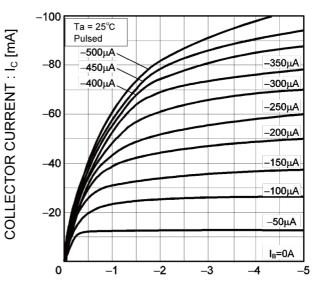


## •Electrical characteristic curves(T<sub>a</sub> = 25°C)



## Fig.1 Ground Emitter Propagation Characteristics

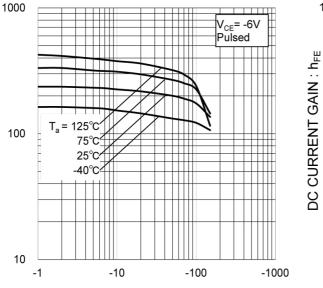
Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE :  $V_{\text{CE}}\left[V\right]$ 

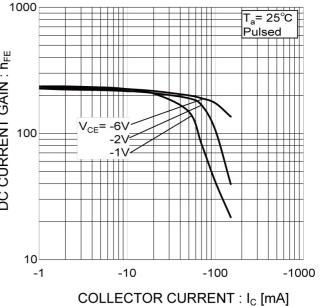
# Fig.3 DC Current Gain vs. Collector Current (I)

DC CURRENT GAIN : h<sub>FE</sub>

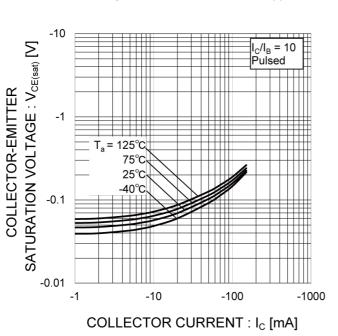


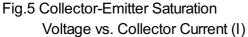
COLLECTOR CURRENT : Ic [mA]

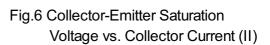
## Fig.4 DC Current Gain vs. Collector Current (II)



## •Electrical characteristic curves(T<sub>a</sub> = 25°C)







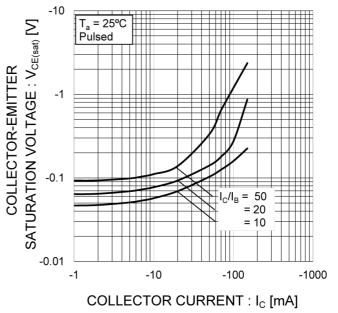


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

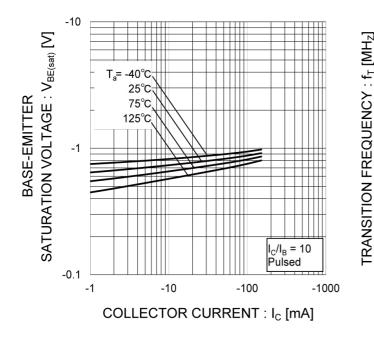
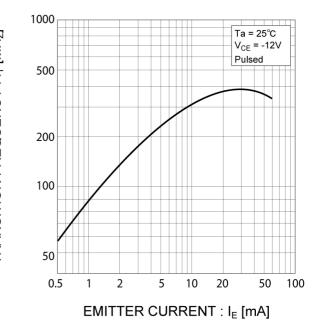


Fig.8 Gain Bandwidth Product vs. Emitter Current





Datasheet

## • Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.9 Emitter Input Capacitance vs. Emitter-Base Voltage Collector Output Capacitance vs. Collector-Base Voltage

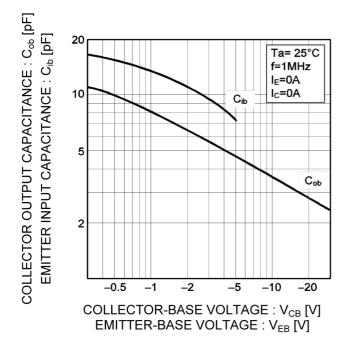


Fig.11 Safe Operating Area (II)

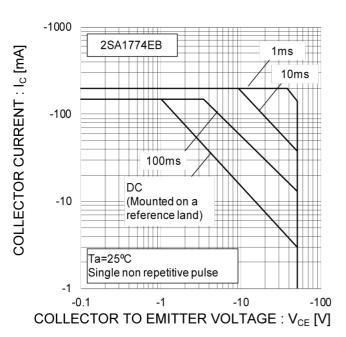


Fig.10 Safe Operating Area (I)

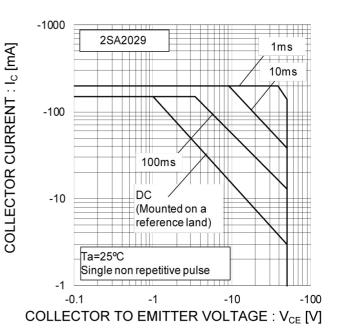


Fig.12 Safe Operating Area (III)

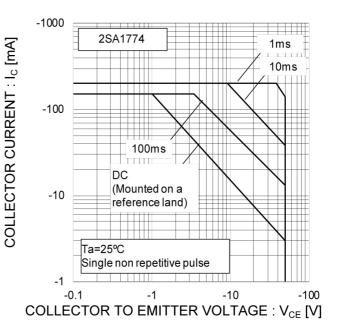




Fig.14 Safe Operating Area (V)

## •Electrical characteristic curves(Ta=25°C)

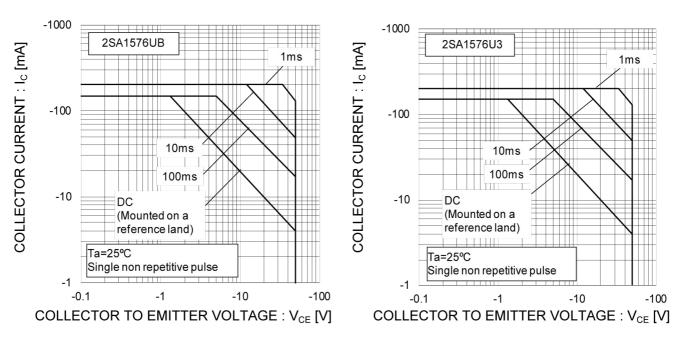
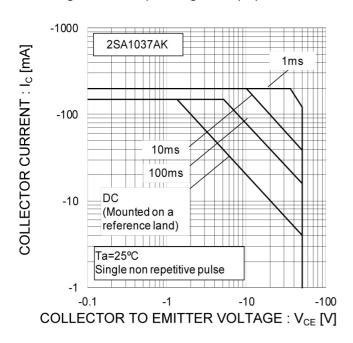
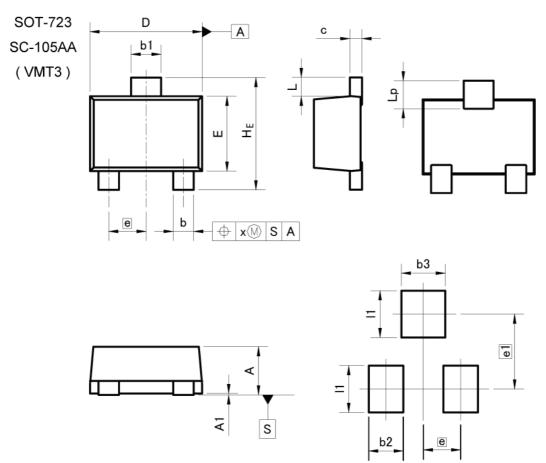


Fig.13 Safe Operating Area (IV)

Fig.15 Safe Operating Area (VI)



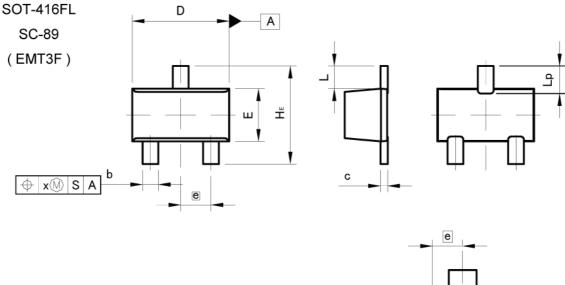


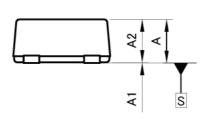


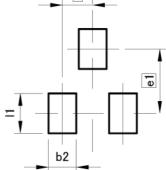
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
A	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
с	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.40		0.02	
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
x	-	0.10	-	0.004
DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	-	0.015
b3	1	0.47		0.019
e1	0.	80	0.0	31
1	-	0.50		0.020







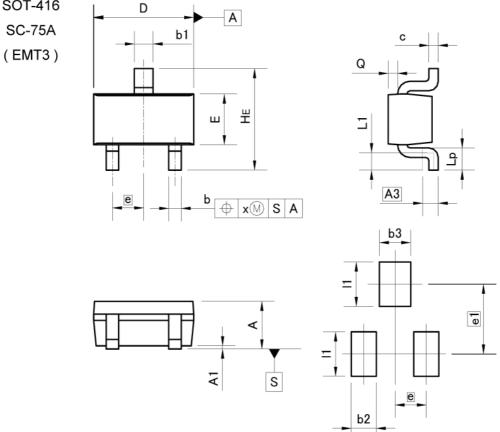


Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
с	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.50		0.020	
HE	1.50	1.70	0.059	0.067
L	0.3	37	0.015	
Lp	0.35	0.55	0.014	0.022
x	—	0.10	-	0.004
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	-	0.46	-	0.018
e1	—	1.05	-	0.041
1	-	0.65	-	0.026



SOT-416 SC-75A

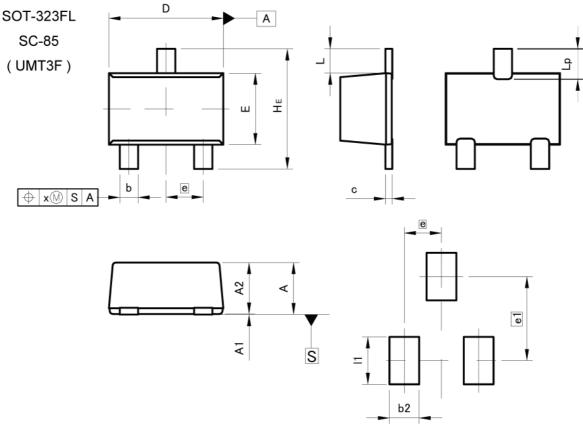


Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
A	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
с	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.020	
HE	1.40	1.80	0.055	0.071
L1	0.10	-	0.004	-
Lp	0.15	-	0.006	
Q	0.05	0.25	0.002	0.010
x	-	0.10	177 A	0.004

	MILIM	ETERS	INCHES	
	MIN	MAX	MIN	MAX
b2	1	0.40	-	0.016
b3	-	0.50	-	0.020
e1	1.10		0.0	43
1	s.—	0.70		0.028



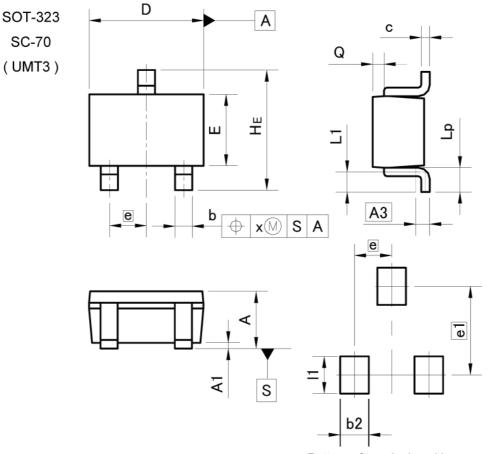


Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
с	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.026	
HE	2.00	2.20	0.079	0.087
L	0.4	43	0.017	
Lp	0.43	0.63	0.017	0.025
x	—	0.10	-	0.004
DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
b2		0.52	-	0.020
e1	1.4	47	0.058	
- 11	-	0.83	—	0.033







Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
A	0.80	1.00	0.031	0.039
A1	0.00	0.10	0	0.004
A3	0.2	25	0.0	01
b	0.25	0.40	0.01	0.016
с	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.03	
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.02
Lp	0.25	0.55	0.01	0.022
Q	0.10	0.30	0.004	0.012
х	_	0.10	_	0.004

	MILIM	ETERS	INCHES	
	MIN	MAX	MIN	MAX
e1	1.55		0.06	
b2	Ι	0.50	-	0.02
1	-	0.65	-	0.026





Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
А	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	-	0.10	-	0.004
У	- 2	0.10	-	0.004
DIM	MILIMETERS		INCHES	
	MIN	ΜΔΥ	MIN	ΜΔΥ

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	-	0.60	-	0.024
e1	2.10		0.083	
1	-	0.90	-	0.035



# Notice

#### Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (<sup>Note 1)</sup>, transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications
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JÁPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSⅢ
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

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  - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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When disposing Products please dispose them properly using an authorized industry waste company.

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